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FAIRCHILD SEMICONDUCTOR®

November 2013

FDPF4N60NZ

N-Channel UniFET^{TM} II MOSFET

600 V, 3.8 A, 2.5 Ω

Features

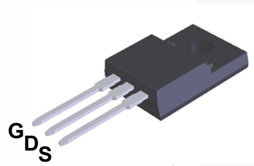
- $R_{DS(on)}$ = 1.9 Ω (Typ.) @ V_{GS} = 10 V, I_D = 1.9 A
- Low Gate Charge (Typ. 8.3 nC)
- Low C_{rss} (Typ. 3.7 pF)
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Improved Capability
- RoHS Compliant

Applications

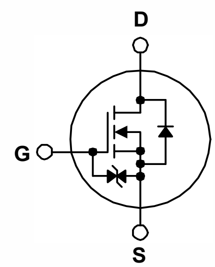
- Consumer Appliances
- Lighting
- Uninterruptible Power Supply
- AC-DC Power Supply

Description

UniFET^{TM} II MOSFET is Fairchild Semiconductor's high voltage MOSFET family based on advanced planar stripe and DMOS technology. This advanced MOSFET family has the smallest on-state resistance among the planar MOSFET, and also provides superior switching performance and higher avalanche energy strength. In addition, internal gate-source ESD diode allows UniFET II MOSFET to withstand over 2kV HBM surge stress. This device family is suitable for switching power converter applications such as power factor correction (PFC), flat panel display (FPD) TV power, ATX and electronic lamp ballasts.



TO-220F



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FDPF4N60NZ	Unit
V_{DSS}	Drain to Source Voltage			600	V
V_{GSS}	Gate to Source Voltage			±25	V
I_D	Drain Current	- Continuous (T_C = 25°C)		3.8*	A
		- Continuous (T_C = 100°C)		2.3*	
I_{DM}	Drain Current	- Pulsed	(Note 1)	15*	A
E_{AS}	Single Pulsed Avalanche Energy		(Note 2)	223.8	mJ
I_{AR}	Avalanche Current		(Note 1)	3.8	A
E_{AR}	Repetitive Avalanche Energy		(Note 1)	8.9	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	10	V/ns
P_D	Power Dissipation	(T_C = 25°C)		28	W
		- Derate Above 25°C		0.22	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range			-55 to +150	°C
T_L	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C

*Drain current limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	FDPF4N60NZ	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	4.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDPF4N60NZ	FDPF4N60NZ	TO-220F	Tube	N/A	N/A	50 units

Electrical Characteristics $T_C = 25^oC$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Off Characteristics						
BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250\ \mu A$, $V_{GS} = 0\ V$, $T_C = 25^oC$	600	-	-	V
$\Delta BV_{DSS} / \Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D = 250\ \mu A$, Referenced to 25^oC	-	0.6	-	V/^{o}C
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 600\ V$, $V_{GS} = 0\ V$	-	-	1	µA
		$V_{DS} = 480\ V$, $V_{GS} = 0\ V$, $T_C = 125^oC$	-	-	10	
I_{GSS}	Gate to Body Leakage Current	$V_{GS} = \pm 25\ V$, $V_{DS} = 0\ V$	-	-	±10	µA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS} = V_{DS}$, $I_D = 250\ \mu A$	3.0	-	5.0	V
$R_{DS(on)}$	Static Drain to Source On Resistance	$V_{GS} = 10\ V$, $I_D = 1.9\ A$	-	1.9	2.5	Ω
g_{FS}	Forward Transconductance	$V_{DS} = 20\ V$, $I_D = 1.9\ A$	-	3.3	-	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 25\ V$, $V_{GS} = 0\ V$, f = 1 MHz	-	385	510	pF
C_{oss}	Output Capacitance		-	40	60	pF
C_{rss}	Reverse Transfer Capacitance		-	3.7	5	pF
$Q_{g(tot)}$	Total Gate Charge at 10V	$V_{DS} = 480\ V$ $I_D = 3.8\ A$, $V_{GS} = 10\ V$ (Note 4)	-	8.3	10.8	nC
Q_{gs}	Gate to Source Gate Charge		-	2.1	-	nC
Q_{gd}	Gate to Drain "Miller" Charge		-	3.3	-	nC
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	$V_{DD} = 300\ V$, $I_D = 3.8\ A$, $V_{GS} = 10\ V$, $R_G = 25\ \Omega$ (Note 4)	-	12.7	35.4	ns
t_r	Turn-On Rise Time		-	15.1	40.2	ns
$t_{d(off)}$	Turn-Off Delay Time		-	30.2	70.4	ns
t_f	Turn-Off Fall Time		-	12.8	35.6	ns
Drain-Source Diode Characteristics						
I_S	Maximum Continuous Drain to Source Diode Forward Current		-	-	3.8*	A
I_{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	15	A
V_{SD}	Drain to Source Diode Forward Voltage	$V_{GS} = 0\ V$, $I_{SD} = 3.8\ A$	-	-	1.4	V
t_{rr}	Reverse Recovery Time	$V_{GS} = 0\ V$, $I_{SD} = 3.8\ A$, $dI_F/dt = 100\ A/\mu s$	-	168	-	ns
Q_{rr}	Reverse Recovery Charge		-	0.7	-	µC

Notes:

1. Repetitive rating: pulse-width limited by maximum junction temperature.
2. L = 31 mH, $I_{AS} = 3.8\ A$, $V_{DD} = 50\ V$, $R_G = 25\ \Omega$, starting $T_J = 25°C$.
3. $I_{SD} \le 3.8\ A$, $di/dt \le 200\ A/\mu s$, $V_{DD} \le BV_{DSS}$, starting $T_J = 25°C$.
4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

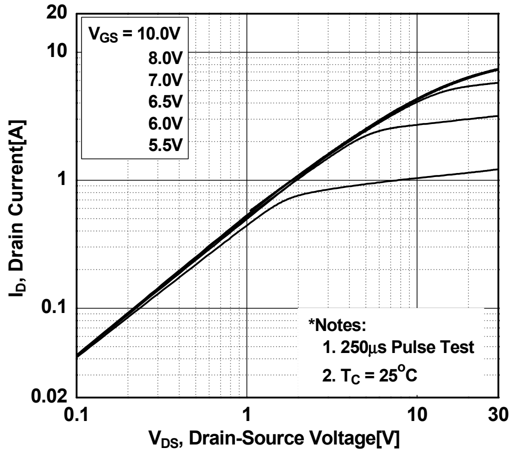


Figure 2. Transfer Characteristics

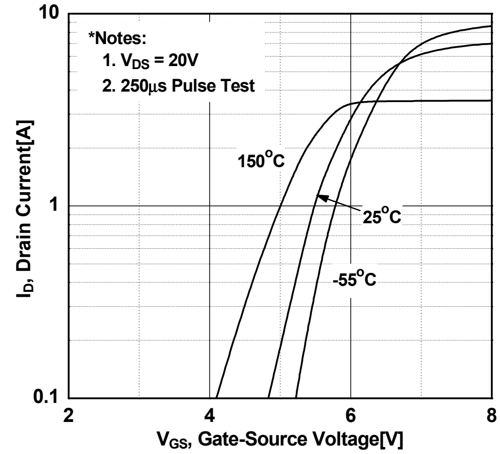


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

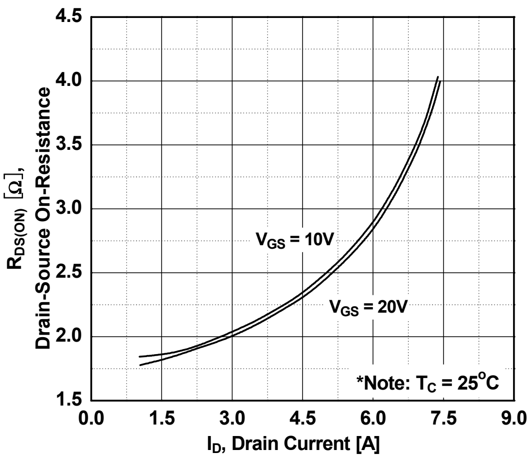


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

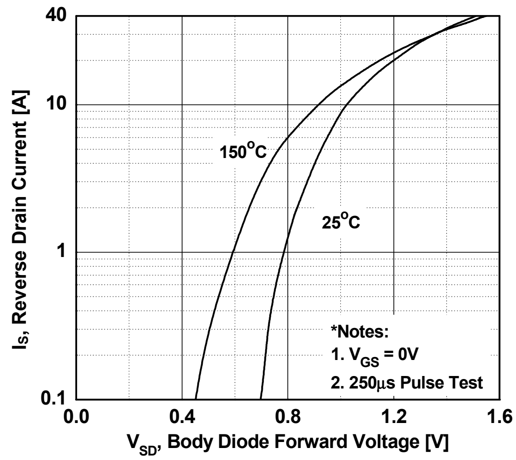


Figure 5. Capacitance Characteristics

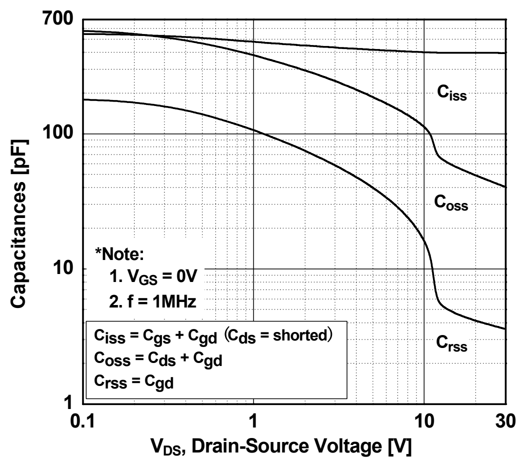
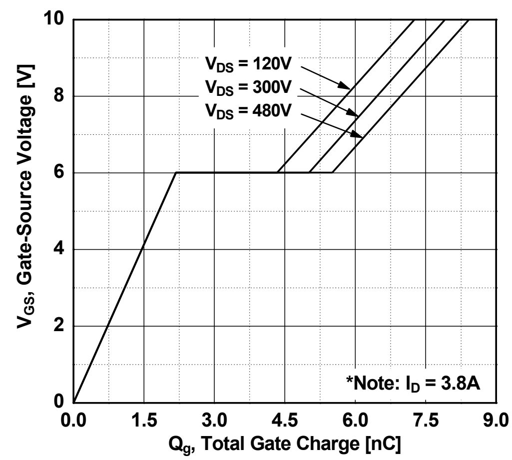


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

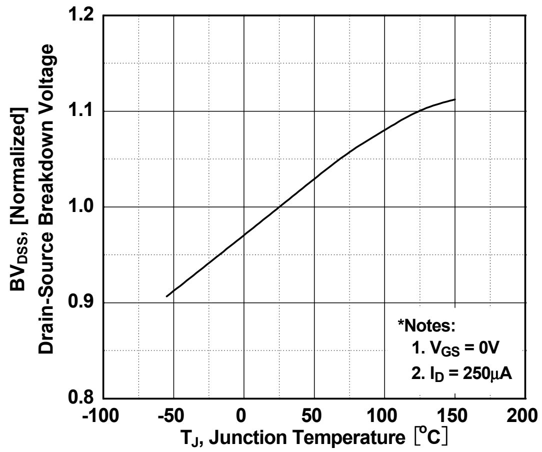


Figure 8. On-Resistance Variation vs. Temperature

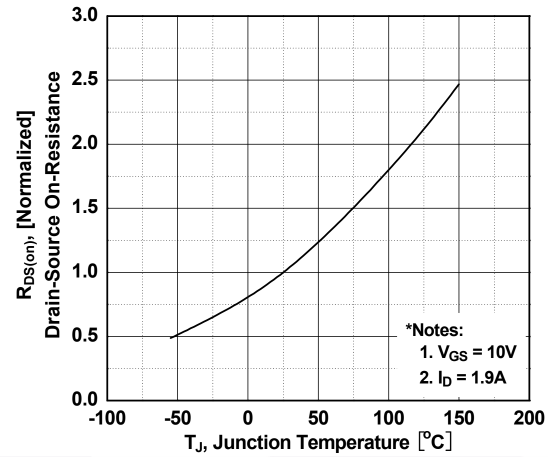


Figure 9. Maximum Safe Operating Area

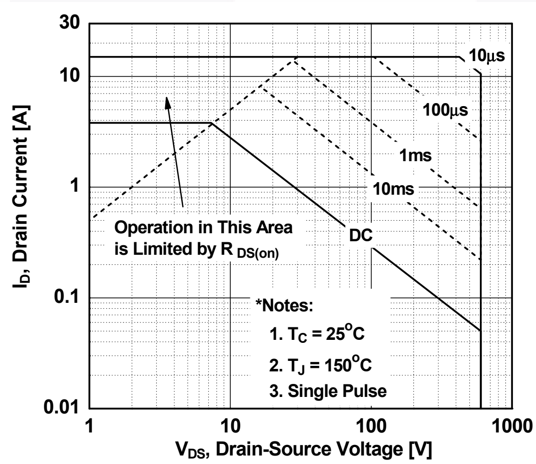


Figure 10. Maximum Drain Current vs. Case Temperature

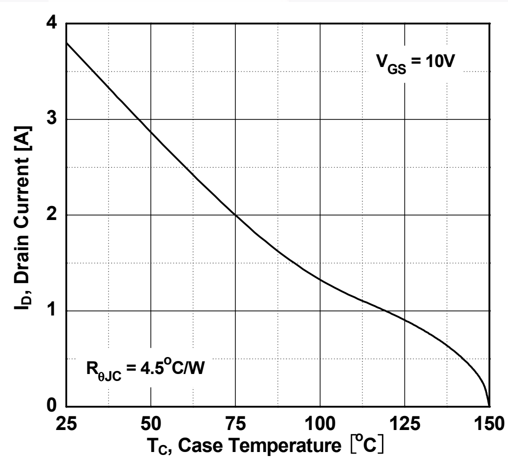
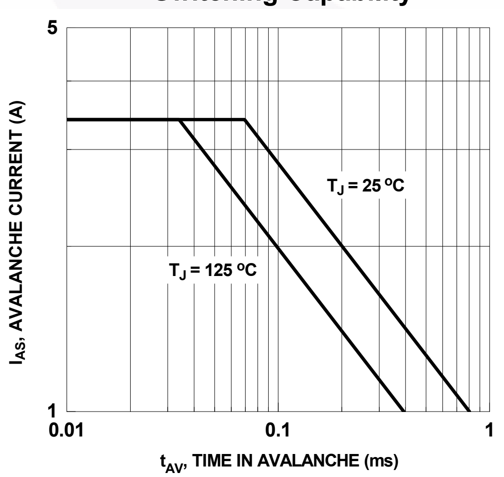
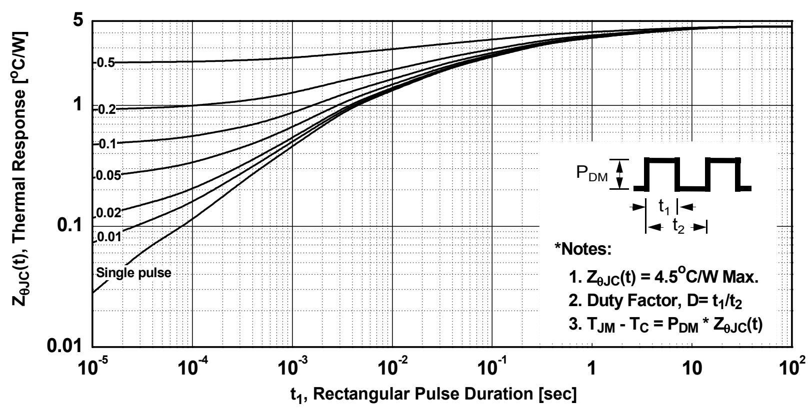


Figure 11. Unclamped Inductive Switching Capability



Typical Performance Characteristics (Continued)

Figure 12. Transient Thermal Response Curve



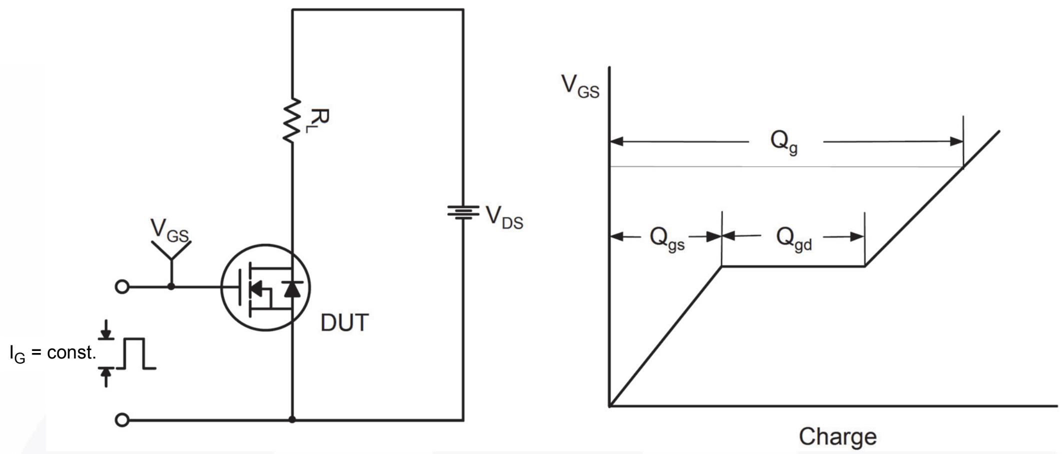


Figure 13. Gate Charge Test Circuit & Waveform

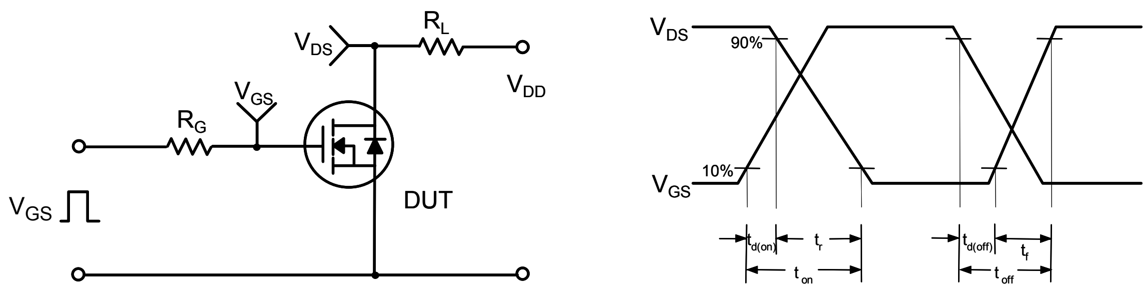


Figure 14. Resistive Switching Test Circuit & Waveforms

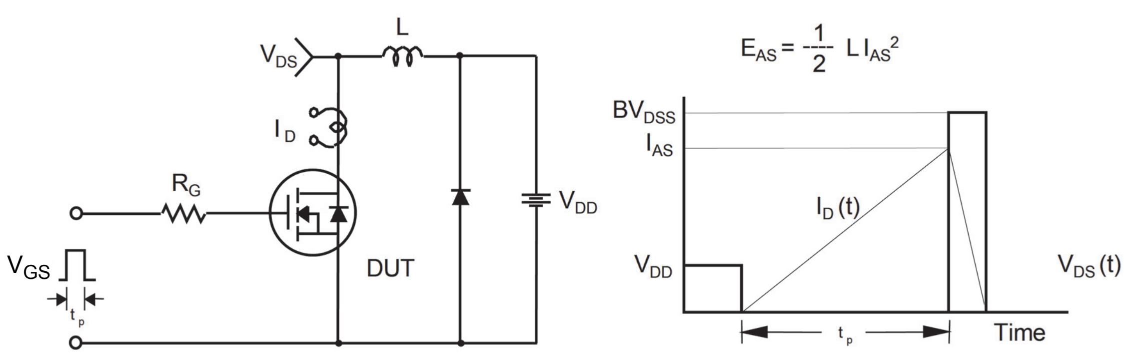


Figure 15. Unclamped Inductive Switching Test Circuit & Waveforms

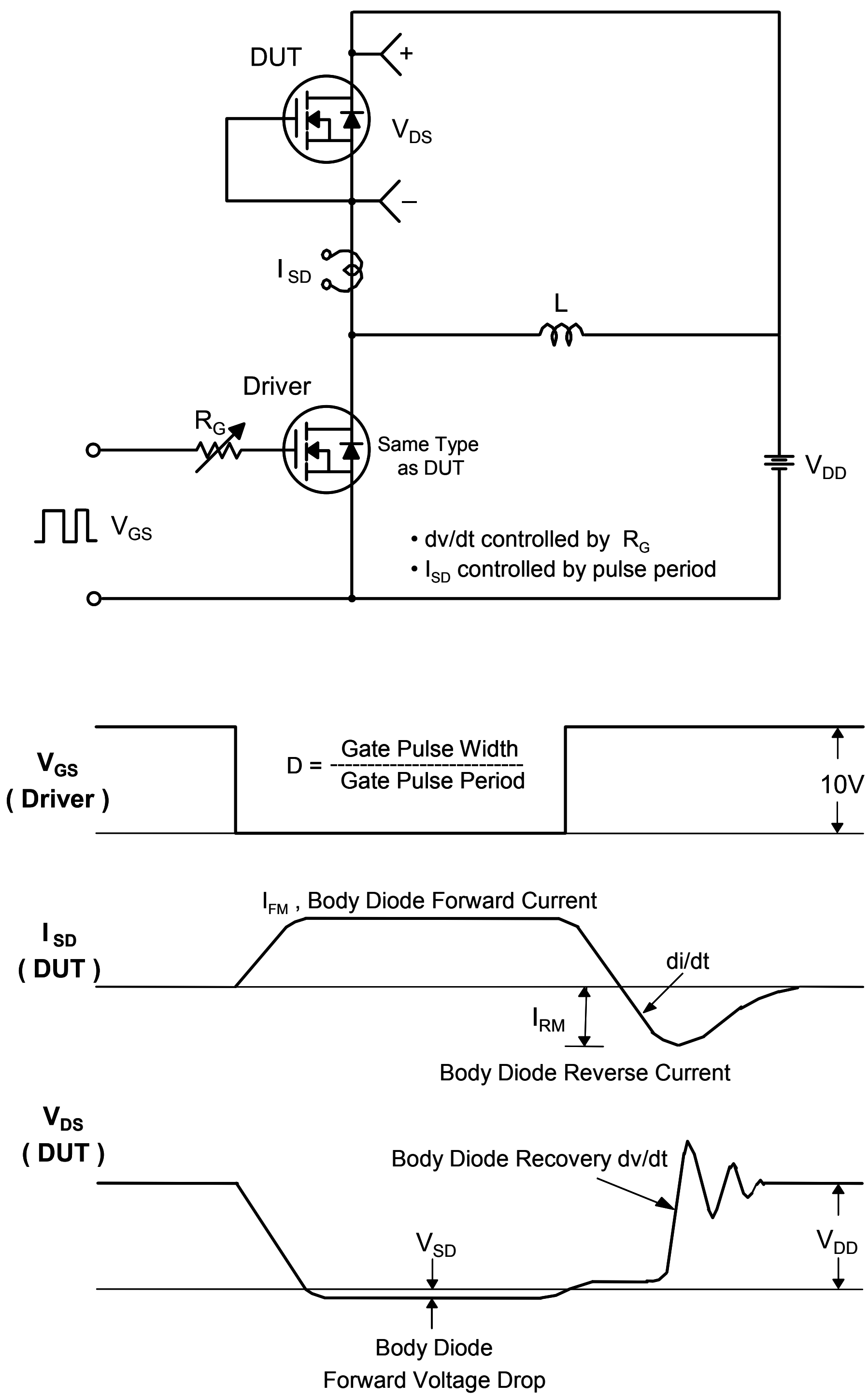


Figure 16. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

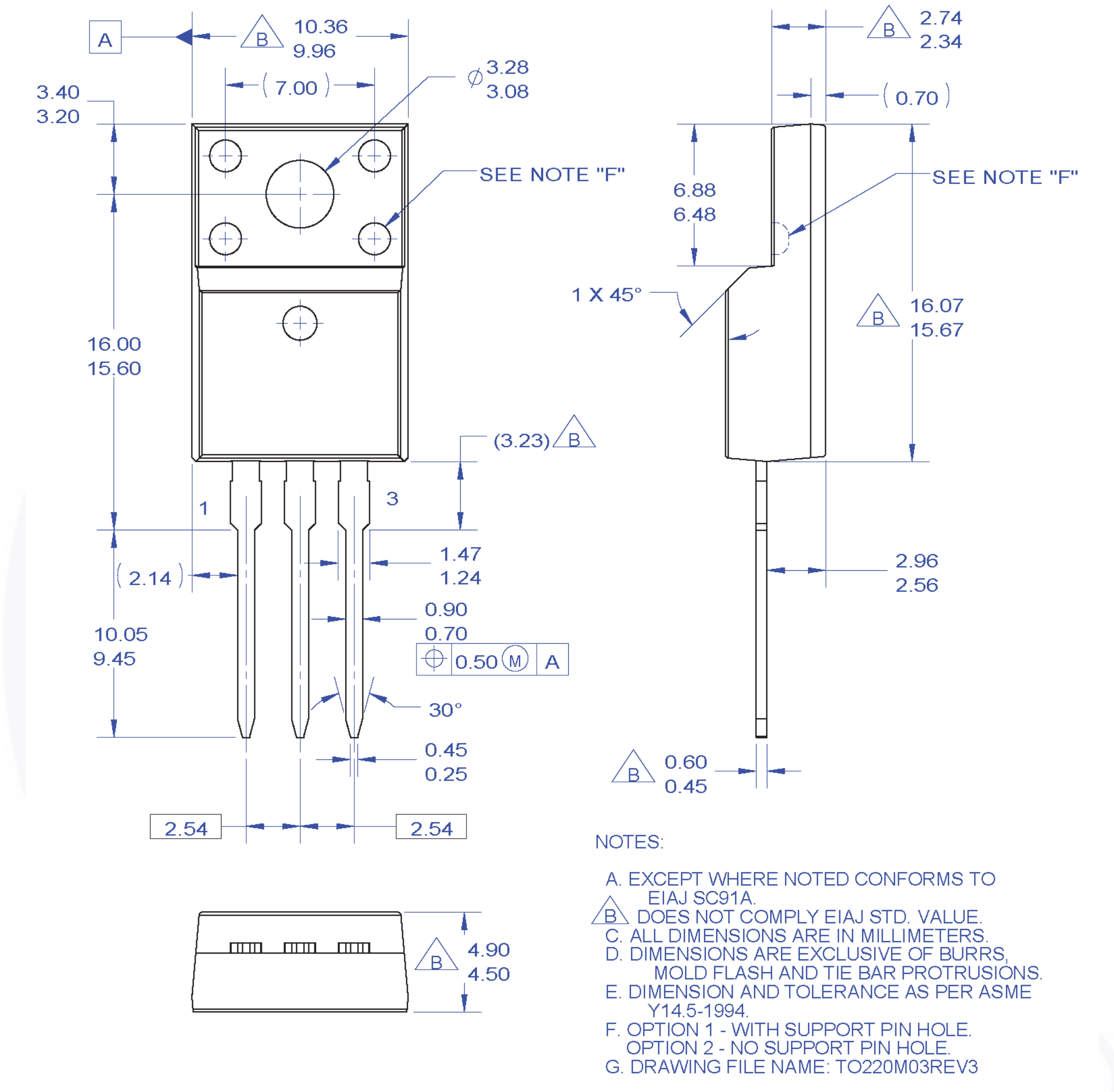


Figure 17. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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Rev. I66

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